

RX Family

CMTW Module Using Firmware Integration Technology

Introduction

The RX Family MCUs supported by this module have two CMTW units. Throughout this document these units are referred as channels. Each channel has one compare match (CM), two output compares (OC0 and OC1), and two input captures (IC0 and IC1). Compare match is a general purpose timer that can be used to generate timer ticks. Output compare and input capture are timers but also have MCU pins associated with them. They are used to generate waveforms based on the timer settings or detect external events and capture the time of the event. The CMTW timers are 32-bit wide allowing from hundreds of nanoseconds to hours of time events to be specified.

This document describes the CMTW FIT Module API for the supported RX class MCUs. Software architecture, system interfaces and usage details are provided here to facilitate integration of the CMTW FIT module into a user's application.

Target Device

- RX26T Group
- RX64M Group
- RX651, RX65N Groups
- RX66N Group
- RX660 Group
- RX671 Group
- RX71M Group
- RX72M Group
- RX72N Group

Target Compilers

- Renesas Electronics C/C++ Compiler Package for RX Family
- · GCC for Renesas RX
- IAR C/C++ Compiler for Renesas RX

For details of the confirmed operation contents of each compiler, refer to "6.1 Operation Confirmation Environment".



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1. Overview

This software provides a unified, abstracted interface for setting up the CMTW peripheral for the supported RX class MCUs. The software also provides support for interrupt handling for the CMTW peripheral and a notification mechanism to the user's application through a callback function.

There are two CMTW channels and therefore a means to identify a particular CMTW channel in each API function is provided. The setup operations are performed in the R_CMTW_Open() API function. This API powers on the specified CMTW channel, initializes it based on the user supplied configuration parameters and enables the interrupts if needed. A pointer to a function called a "callback function" can be provided through this API so that the user is notified when a timer event occurs. This notification operation take place in the CMTW interrupt handlers. Therefore, it is advised that user supplied callback functions complete quickly to allow time to other processes in the system. The API also supports one-shot operations where the requested action is executed only once.

After initialization is complete, the user can start, stop, resume, or restart the timers. This is done by R_CMTW_Control() API. When the CMTW operations are no longer needed, the channel can be closed by R_CMTW_Close() API. This API disables the CMTW channel and powers it off to reduce power consumption.

Figure 1 below shows an example of a high level project view using CMTW FIT module.



CMTW FIT Module FIT BSP

RX MCU CMTW Peripheral

Figure 1 - Example Figure Showing Project Layers

1.1 Using the CMTW Firmware Integration Technology (FIT) module

The primary use of the CMTW module is to make it easy to setup and control the CMTW timers. The user's application can arbitrarily assign a callback function that will execute when a timer event occurs.

After adding the CMTW module to your project you will need to modify the r_cmtw_rx_config.h file to configure the software for your installation. See Section 2.9 for details on configuration options.

Output and input pins used by the CMTW peripheral must be correctly set up before the use of the CMTW module. The module does not provide any means to initialize the pin registers, which needs to be done externally prior to calling CMTW API functions. Typically, this would be accomplished at system startup time as part of a general pin initialization routine. GPIO and MPC FIT modules can be used to setup the pins. Table 1 shows the output and input pin assignments for the CMTW peripheral.

Output and Input Pin Assignments for CMTW						
	RX64M, RX651, RX65N,	Output compare 0 (TOC0)	PC7			
	RX66N ,RX660, RX671, RX71M, RX72M, RX72N	Output compare 1 (TOC1)	PE7			
		Input capture 0 (TIC0)	PC6			
Channel 0		Input capture 1 (TIC1)	PE6			
Channel 0	RX26T	Output compare 0 (TOC0)	PB6			
		Output compare 1 (TOC1)	PB3			
		Input capture 0 (TIC0)	PB5			
		Input capture 1 (TIC1)	PB2			
	RX64M, RX651, RX65N, RX66N ,RX660, RX671,	Output compare 0 (TOC2)	PD3			
	RX71M, RX72M, RX72N	Output compare 1 (TOC3)	PD3 PE3			
		Input capture 0 (TIC2)	PD2			
Channel 1		Input capture 1 (TIC3)	PE2			
Channel 1	RX26T	Output compare 0 (TOC2)	PB1			
		Output compare 1 (TOC3)	P11			
		Input capture 0 (TIC2)	PB0			
	Toble 4 Bin Conf	Input capture 1 (TIC3)	P00			

Table 1 - Pin Configurations for the CMTW

1.2 Interrupts

There is no need to set up interrupt vectors for CMTW as this software provides the interrupt handlers for all CMTW interrupts. Depending on the user supplied configuration parameters to the R_CMTW_Open() API, interrupt only or callback actions can be taken. Interrupt only action is useful if CMTW is used with another peripheral e.g. DTC or DMAC. However, this software does not setup other peripherals that can be used with CMTW.

Callback action is used to notify the user about the CMTW timer events. If requested by the user, the CMTW ISR calls the user supplied callback function. It is within the callback that user code is run in response to the ISR. Since callbacks are being processed within the context of the interrupt and interrupts are disabled at this time, it is strongly recommended that callback function completes as quickly as possible to avoid missing other interrupts that might occur in the system.

In case no interrupts are needed, timer only action can be used. This is useful for producing output compare waveforms without generating interrupts and consuming CPU time.

1.3 Callback Functions

1.3.1 Example callback function prototype declaration.

```
void my cmtw callback(void *pdata);
```

1.3.2 Dereferencing of pdata argument.

The ISR code uses a pointer to a structure defined in the $r_cmtw_rx_if.h$ file to pass the event information to the user callback function. This structure is of type $cmtw_callback_data_t$. Since FIT callback functions take a void pointer, this pointer must be type-casted to $(cmtw_callback_data_t$ *) before it can be dereferenced and access the information provided by the CMTW interrupt handler. The interrupt data structure and types are defined in section 2.11.1.

Example:

```
void my_cmtw_callback(void *pdata)
{
    cmtw_callback_data_t     *p_cb_data = (cmtw_callback_data_t *)pdata;
    ...
    cb_data.channel = p_cb_data->channel;
    cb_data.event = p_cb_data->event;
    cb_data.count = p_cb_data->count;
    ...
}
```

1.4 Using the FIT CMTW module

1.4.1 Using FIT CMTW module in C++ project

For C++ project, add FIT CMTW module interface header file within extern "C"{}:

```
Extern "C"
{
    #include "r_smc_entry.h"
    #include "r_cmtw_rx_if.h"
}
```

2. API Information

This driver API follows the Renesas API naming standards.

2.1 Hardware Requirements

This driver requires that your MCU supports the following peripheral(s):

CMTW

2.2 Hardware Resource Requirements

This section details the hardware peripherals that this driver requires. Unless explicitly stated, these resources must be reserved for the driver, and the user cannot use them.

None.

2.3 Software Requirements

This driver is dependent upon the following FIT packages:

Renesas Board Support Package (r bsp) v5.20 or higher.

This driver assumes that the related I/O pins have been correctly initialized elsewhere prior to calling this software's API functions.

2.4 Limitations

This driver is applicable only to CMTW operations. If another peripheral is linked with CMTW, it must be setup externally. Please see section 2.9 for limitations on the usage of locks and dependency to the BSP.

2.4.1 RAM Location Limitations

In FIT, if a value equivalent to NULL is set as the pointer argument of an API function, error might be returned due to parameter check. Therefore, do not pass a NULL equivalent value as pointer argument to an API function.

The NULL value is defined as 0 because of the library function specifications. Therefore, the above phenomenon would occur when the variable or function passed to the API function pointer argument is located at the start address of RAM (address 0x0). In this case, change the section settings or prepare a dummy variable at the top of the RAM so that the variable or function passed to the API function pointer argument is not located at address 0x0.

In the case of the CCRX project (e2 studio V7.5.0), the RAM start address is set as 0x4 to prevent the variable from being located at address 0x0. In the case of the GCC project (e2 studio V7.5.0) and IAR project (EWRX V4.12.1), the start address of RAM is 0x0, so the above measures are necessary.

The default settings of the section may be changed due to the IDE version upgrade. Please check the section settings when using the latest IDE.

2.5 Supported Toolchains

This driver has been confirmed to work with the toolchain listed in 6.1 Operation Confirmation Environment.



2.6 Interrupt Vector

CMTW interrupt is enabled by execution **R_CMTW_Open()** function.

Table 2.1 Interrupt Vector Used in the CMTW FIT Module lists the interrupt vector used in the CMTW FIT Module.

Table 2.1 Interrupt Vector Used in the CMTW FIT Module

Device	Interrupt Vector
RX64M	 CMWI0 interrupt[channel 0] (vector no.: 30)
RX651, RX65N RX66N	CMWI1 interrupt[channel 1] (vector no.: 31)
RX660 RX671	• IC0I0 interrupt[channel 0] (vector no.: 168)*1
RX71M, RX72M RX72N	• IC1I0 interrupt[channel 0] (vector no.: 169)*1
	 OC0I0 interrupt[channel 0] (vector no.: 170)*1
	 OC1I0 interrupt[channel 0] (vector no.: 171)*1
	 IC0I1 interrupt[channel 1] (vector no.: 172)*1
	• IC1I1 interrupt[channel 1] (vector no.: 173)*1
	 OC0I1 interrupt[channel 1] (vector no.: 174)*1
	 OC1I1 interrupt[channel 1] (vector no.: 175)*1
RX26T	CMWI0 interrupt[channel 0] (vector no.: 186)
	CMWI1 interrupt[channel 1] (vector no.: 191)
	IC0I0 interrupt[channel 0] (vector no.: 187)
	IC1I0 interrupt[channel 0] (vector no.: 188)
	OC0I0 interrupt[channel 0] (vector no.: 189)
	OC1I0 interrupt[channel 0] (vector no.: 190)
	IC0I1 interrupt[channel 1] (vector no.: 192)
	IC1I1 interrupt[channel 1] (vector no.: 193)
	OC0I1 interrupt[channel 1] (vector no.: 194)
	OC1I1 interrupt[channel 1] (vector no.: 195)

Note 1. The interrupt vector numbers for software configurable interrupt B show the default values specified in the board support package FIT module (BSP module).

2.7 Header Files

All API calls and their supporting interface definitions are located in "r_cmtw_rx_if.h".



Build-time configuration options are selected or defined in the file "r_cmtw_rx_config.h".

Both of these files should be included by the user's application.

2.8 Integer Types

This project uses ANSI C99 "Exact width integer types" in order to make the code clearer and more portable. These types are defined in *stdint.h*.

2.9 Configuration Overview

Some features or behavior of the software are determined at build-time by configuration options that the user must select.

Configuration op	tions in r_cmtw_rx_config.h
	This macro is used to enable parameter checking for CMTW API functions. Disabling the parameter checking is provided for systems that absolutely require faster and smaller code.
CMTW_CFG_PARAM_CHECKING_ENABLE	By default the module is configured to use the setting of the system-wide BSP_CFG_PARAM_CHECKING_ENABLE macro. This can be locally overridden for the CMTW module by redefining the macro. To control parameter checking locally, set the macro to 1 to enable or to 0 to disable the checking.
	This macro is used to lock the API functions while they are being used to prevent simultaneous calls to them. This prevents multiple accesses to the API function within an RTOS environment.
CMTW_CGF_REQUIRE_LOCK	By default the module is configured to enable the locking. If the system is not multitasked and there is no possibility of running multiple instances of the API functions, this macro can be set to 0 to disable the locking to save code space.
CWTW_CFG_IPR_CM_CH0	This macro defines the priority level for compare match interrupt for channel 0. Valid values are 1 to 15.
CMTW_CFG_IPR_OC0_CH0	This macro defines the priority level for output compare 0 interrupt for channel 0. Valid values are 1 to 15.
CMTW CFG IPR OC1 CH0	This macro defines the priority level for output compare 1 interrupt for channel 0. Valid values are 1 to 15.
CMTW CFG IPR IC0 CH0	This macro defines the priority level for input capture 0 interrupt for channel 0. Valid values are 1 to 15.
CMTW CFG IPR IC1 CH0	This macro defines the priority level for input capture 1 interrupt for channel 0. Valid values are 1 to 15.
CWTW CFG IPR CM CH1	This macro defines the priority level for compare match interrupt for channel 1. Valid values are 1 to 15.
CMTW CFG IPR OC0 CH1	This macro defines the priority level for output compare 0 interrupt for channel 1. Valid values are 1 to 15.
CMTW CFG IPR OC1 CH1	This macro defines the priority level for output compare 1 interrupt for channel 1. Valid values are 1 to 15.
CMTW CFG IPR IC0 CH1	This macro defines the priority level for input capture 0 interrupt for channel 1. Valid values are 1 to 15.
CMTW CFG IPR IC1 CH1	This macro defines the priority level for input capture 1 interrupt for channel 1. Valid values are 1 to 15.
CMTW_CFG_EN_NESTED_INT	Specifies whether to include code for nested interrupt 0: Disable nested interrupt 1: Enable nested interrupt. (default value = 0)
	(uciauli value – 0)

Table 2 - List of CMTW module configuration options

2.10 Code Size

Typical code sizes associated with this module are listed below.

The ROM (code and constants) and RAM (global data) sizes are determined by the build-time configuration options described in 2.9, Configuration Overview. The table lists reference values when the C compiler's compile options are set to their default values, as described in 2.5, Supported Toolchains. The compile option default values are optimization level: 2, optimization type: for size, and data endianness: little-endian. The code size varies depending on the C compiler version and compile options.

			RC	OM, RAM an	nd Stack Co	de Sizes			
Devices	es Category Memory Used					Remarks			
			Renesas	Compiler	G	cc	IAR C	ompiler	
			With Parameter Checking and Require Locking	Without Parameter Checking and Require Locking	With Parameter Checking and Require Locking	Without Parameter Checking and Require Locking	With Parameter Checking and Require Locking	Without Parameter Checking and Require Locking	
	ROM	1 channel	2025 bytes	1798 bytes	3036	2708	4746	4439	
		used	2020 bytes	1750 bytes	bytes	bytes	bytes	bytes	
		2 channels used	2522 bytes	2295 bytes	3632	3304	5199	4892 bytes	
		useu			bytes	bytes	bytes		
RX64M	RAM	1 channel used	32 bytes	32 bytes	0 bytes	0 bytes	16 bytes	16 bytes	
		2 channels used	64 bytes	64 bytes	0 bytes	0 bytes	32 bytes	32 bytes	
	Maximi usage	um stack	64 bytes	64 bytes	-	-	176 bytes	176 bytes	
	ROM	1 channel used	2025 bytes	1798 bytes	3036	2708	4746	4439	
		useu	2020 bytes	1700 Dytes	bytes	bytes	bytes	bytes	
		2 channels used	2522 bytes	2295 bytes	3632 bytes	3304 bytes	5199 bytes	4892 bytes	
RX65N	RAM	1 channel used	32 bytes	32 bytes	0 bytes	0 bytes	16 bytes	16 bytes	
		2 channels used	64 bytes	64 bytes	0 bytes	0 bytes	32 bytes	32 bytes	
	Maximi usage	um stack	64 bytes	64 bytes	-	-	176 bytes	176 bytes	
	ROM	1 channel used	2025 bytes	1664 bytes	3036 bytes	2708 bytes	4746 bytes	4439 bytes	
		2 channels used	2522 bytes	2161 bytes	3632 bytes	3304 bytes	5199 bytes	4892 bytes	
RX71M	RAM	1 channel used	32 bytes	32 bytes	0 bytes	0 bytes	16 bytes	16 bytes	
		2 channels used	64 bytes	64 bytes	0 bytes	0 bytes	32 bytes	32 bytes	
	Maximi usage	um stack	64 bytes	64 bytes	-	-	176 bytes	176 bytes	

ROM, RAM and Stack Code Sizes									
Devices	Category Memory Used					Remarks			
			Renesas With Parameter Checking and Require Locking	Compiler Without Parameter Checking and Require Locking	With Parameter Checking and Require Locking	Without Parameter Checking and Require Locking	IAR Co With Parameter Checking and Require Locking	ompiler Without Parameter Checking and Require Locking	
	ROM	1 channel used	2033 bytes	1806 bytes	3356	2972	2917	2606	
		useu	2000 bytes	1000 bytes	bytes	bytes	bytes	bytes	
		2 channels used	2530 bytes	2303 bytes	3952	3568	3371	3060	
		useu	2000 57100	2000 27100	bytes	bytes	bytes	bytes	
RX72M	RAM	1 channel used	32 bytes	32 bytes	0 bytes	0 bytes	16 bytes	16 bytes	
		2 channels used	64 bytes	64 bytes	0 bytes	0 bytes	32 bytes	32 bytes	
	Maximi usage	um stack	120 bytes	120 bytes	-	-	220 bytes	220 bytes	
	ROM	1 channel used	2089 bytes	1862 bytes	3401	3020	4599	4288	
		uscu	2000 57100	1002 5 9100	bytes	bytes	bytes	bytes	
		2 channels used	2586 bytes	2359 bytes	3997	3616	5048	4737	
		uscu	2000 bytes	2000 bytes	bytes	bytes	bytes	bytes	
RX72N	RAM	1 channel used	32 bytes	32 bytes	32 bytes	32 bytes	16 bytes	16 bytes	
		2 channels used	64 bytes	64 bytes	64 bytes	64 bytes	32 bytes	32 bytes	
	Maximi usage	um stack	80 bytes	80 bytes	-	-	136 bytes	136 bytes	
	ROM	1 channel used	2089 bytes	1862 bytes	3448	2996	4591	4292	
		useu	2009 Dytes	1002 bytes	bytes	bytes	bytes	bytes	
		2 channels	2586 bytes	2359 bytes	4044	3592	5040	4741	
		used	2000 bytes	2339 bytes	bytes	bytes	bytes	bytes	
RX66N	RAM	1 channel used	32 bytes	32 bytes	32 bytes	32 bytes	16 bytes	16 bytes	
		2 channels used	64 bytes	64 bytes	64 bytes	64 bytes	32 bytes	32 bytes	
	Maximi usage	um stack	80 bytes	80 bytes	-	-	136 bytes	136 bytes	
	ROM	1 channel used	2061 bytes	1859 bytes	3404 bytes	3020 bytes	2786 bytes	2546 bytes	
		2 channels used	2558 bytes	2392 bytes	3960 bytes	3576 bytes	3230 bytes	2990 bytes	
RX671	RAM	1 channel used	32 bytes	32 bytes	32 bytes	32 bytes	16 bytes	16 bytes	
		2 channels used	64 bytes	64 Bytes	64 bytes	64 bytes	32 bytes	32 bytes	
	Maximi usage	um stack	64 bytes	64 bytes	-	-	136 bytes	136 bytes	

	ROM, RAM and Stack Code Sizes								
Devices	Category		Memory Used						
				Compiler		cc		ompiler	
			With Parameter Checking and Require Locking	Without Parameter Checking and Require Locking	With Parameter Checking and Require Locking	Without Parameter Checking and Require Locking	With Parameter Checking and Require Locking	Without Parameter Checking and Require Locking	
	ROM	1 channel used	2030 bytes	1831 bytes	3404 bytes	3020 bytes	4653 bytes	4346 bytes	
		2 channels used	2527 bytes	2328 bytes	3960bytes	3408 bytes	5012 bytes	4795 bytes	
RX660	RAM	1 channel used	32 bytes	32 bytes	0 bytes	0 bytes	16 bytes	16 bytes	
		2 channels used	64 bytes	64 bytes	128 bytes	128 bytes	32 bytes	32 bytes	
	Maximi usage	um stack	76 bytes	76 bytes	-	-	136 bytes	136 bytes	
	ROM	1 channel used	2120 bytes	1921 bytes	2364 bytes	2036 bytes	4570 bytes	4263 bytes	
		2 channels used	2707 bytes	2508 bytes	2904 bytes	2576 bytes	5015 bytes	4708 bytes	
RX26T	RAM	1 channel used	32 bytes	32 bytes	128 bytes	128 bytes	16 bytes	16 bytes	
		2 channels used	64 bytes	64 bytes	128 bytes	128 bytes	32 bytes	32 bytes	
	Maximi usage	um stack	76 bytes	76 bytes	-	-	152 bytes	152 bytes	

2.11 API Data Types

This section details the data structures that are used with the driver's API functions.

2.11.1 Special Data Types

To provide strong type checking and reduce errors, many parameters used in API functions require arguments to be passed using the provided type definitions. Allowable values are defined in the public interface file *r_cmtw_rx_if.h.* The following special types have been defined:

```
/* Channel numbers */
typedef enum
{
    CMTW\_CHANNEL\_0 = 0,
    CMTW_CHANNEL_1,
    CMTW_CHANNEL MAX,
} cmtw channel t;
/* Time base */
typedef enum
    CMTW TIME NSEC = 0,
    CMTW TIME USEC,
    CMTW TIME MSEC,
    CMTW TIME SEC,
    CMTW TIME MAX,
} cmtw time unit t;
/* PCLK divisor */
typedef enum
                                   // PCLK/8
// PCLK/32
// PCLK/128
// PCLK/512
    CMTW_CLK_DIV_8 = 0,
CMTW_CLK_DIV_32,
    CMTW CLK DIV 128,
    CMTW CLK DIV 512,
    CMTW CLK DIV MAX,
} cmtw clock divisor t;
/* Counter clearing source */
typedef enum
{
    CMTW CLR CMT = 0,
    CMTW CLR DISABLED = 1,
    CMTW CLR ICO = 4,
    CMTW CLR IC1
                           = 5,
                           = 6,
    CMTW CLR OC0
    CMTW CLR OC1
                           = 7,
    CMTW CLR MAX,
} cmtw clear source t;
/* Actions to take */
typedef enum
    CMTW_ACTION_NONE = 0x00, // Do nothing with this timer
CMTW_ACTION_TIMER = 0x01, // Run timer only no interrupt
CMTW_ACTION_INTERRUPT = 0x02, // Generate interrupt request
CMTW_ACTION_CALLBACK = 0x04, // Generate interrupt request
                                               // Generate interrupt request and
                                                // execute user-defined callback
                                                // Generate interrupt, act only once,
    CMTW\_ACTION\_ONESHOT = 0x08,
                                                 // and turn off
} cmtw actions t;
/* Output pin states */
```

```
typedef enum
    // Output hi initially and toggle
    CMTW OUTPUT MAX,
} cmtw output states t;
/* Input pin edges to capture */
typedef enum
{
    // Capture falling edge
    CMTW EDGE ANY,
                                           // Capture both rising and falling edges
    CMTW EDGE MAX,
} cmtw edge states t;
/* Control function command codes. */
typedef enum
    } cmtw_cmd_t;
/* Open function CM settings */
typedef struct
    uint32_t
cmtw_actions_t
                             time;
                             actions;
} cmtw cm settings t;
/* Open function OC settings */
typedef struct
    actions;
    cmtw output states t output;
} cmtw oc settings t;
/* Open function IC settings */
typedef struct
    cmtw actions t
                            actions;
    cmtw edge states t
                             edge;
} cmtw ic settings t;
/* Open function channel settings */
typedef struct
cmtw_time_unit_t
  cmtw_clock_divisor_t
  cmtw_clear_source_t
  cmtw_cm_settings_t
  cmtw_oc_settings_t
  cmtw_ic_settings_t
  cmtw_ic_settings_t
  cmtw_ic_settings_t
  cmtw_ic_settings_t
  cmtw_ic_settings_t
  cmtw_ic_settings_t
  cmtw_ic_settings_t
} cmtw_channel_settings_t;
time_unit;
clock_divisor;
clear_source;
cm_timer;
oc_timer_0;
ic_timer_0;
ic_timer_1;
}
cmtw_channel_settings_t;
```

2.12 Return Values

This shows the different values API functions can return. This return type is defined in "r_cmtw_rx_if.h".

```
/* CMTW function return codes */
typedef enum
{
    CMTW_SUCCESS = 0,
    CMTW_ERR_BAD_CHAN,
    CMTW_ERR_CH_NOT_ENABLED,
    CMTW_ERR_CH_NOT_OPENED,
    CMTW_ERR_CH_NOT_CLOSED,
    CMTW_ERR_CH_NOT_CLOSED,
    CMTW_ERR_CH_NOT_STOPPED,
    CMTW_ERR_CH_NOT_STOPPED,
    CMTW_ERR_CH_NOT_STOPPED,
    CMTW_ERR_UNKNOWN_CMD,
    CMTW_ERR_INVALID_ARG,
    CMTW_ERR_NULL_PTR,
    CMTW_ERR_LOCK,
    CMTW_ERR_OUT_OF_RANGE,
} cmtw_err_t;
// Calculated count value is not in range
```

2.13 Adding the FIT Module to Your Project

This module must be added to each project in which it is used. Renesas recommends the method using the Smart Configurator described in (1), (2) or (3) below. However, the Smart Configurator only supports some RX devices. Please use the methods of (4) for RX devices that are not supported by the Smart Configurator.

- (1) Adding the FIT module to your project using the Smart Configurator in e² studio
 By using the Smart Configurator in e² studio, the FIT module is automatically added to your project.
 Refer to "Renesas e² studio Smart Configurator User Guide (R20AN0451)" for details.
- (2) Adding the FIT module to your project using the Smart Configurator in CS+ By using the Smart Configurator Standalone version in CS+, the FIT module is automatically added to your project. Refer to "Renesas e² studio Smart Configurator User Guide (R20AN0451)" for details.
- (3) Adding the FIT module to your project using the Smart Configurator in IAREW By using the Smart Configurator Standalone version, the FIT module is automatically added to your project. Refer to "RX Smart Configurator User's Guide: IAREW (R20AN0535)" for details.
- (4) Adding the FIT module to your project in CS+ In CS+, please manually add the FIT module to your project. Refer to "Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)" for details.

2.14 "for", "while" and "do while" statements

In this module, "for", "while" and "do while" statements (loop processing) are used in processing to wait for register to be reflected and so on. For these loop processing, comments with "WAIT_LOOP" as a keyword are described. Therefore, if user incorporates fail-safe processing into loop processing, user can search the corresponding processing with "WAIT_LOOP".

The following shows example of description.

```
while statement example :
/* WAIT_LOOP */
while(0 == SYSTEM.OSCOVFSR.BIT.PLOVF)
{
    /* The delay period needed is to make sure that the PLL has stabilized. */
}

for statement example :
/* Initialize reference counters to 0. */
/* WAIT_LOOP */
for (i = 0; i < BSP_REG_PROTECT_TOTAL_ITEMS; i++)
{
    g_protect_counters[i] = 0;
}

do while statement example :
/* Reset completion waiting */
do
{
    reg = phy_read(ether_channel, PHY_REG_CONTROL);
    count++;
} while ((reg & PHY_CONTROL_RESET) && (count < ETHER_CFG_PHY_DELAY_RESET)); /* WAIT_LOOP */</pre>
```

3. API Functions

R CMTW Open()

This function powers up the specified CMTW channel, initializes the associated CMTW registers and enables interrupts if requested. Takes a callback function pointer for responding to interrupt events. After successful completion, the channel moves to open state. This function must be called before calling any other API functions.

Format

Parameters

channel

Number of the CMTW channel to initialize

pconfig

Pointer to the CMTW channel settings data structure

pcallback

Pointer to the user function to call from the interrupt

Return Values

CMTW SUCCESS Successful, channel is initialized

CMTW ERR BAD CHAN Invalid channel number

CMTW_ERR_CH_NOT_ENABLED Channel is disabled by user configuration

CMTW_ERR_CH_NOT_CLOSED Channel currently in operation, perform R_CMTW_Close() first CMTW_ERR_INVALID_ARG An element of the pconfig structure contains an invalid value

CMTW_ERR_OUT_OF_RANGE Calculated count value is not in range
CMTW ERR NULL PTR Either pconfig or pcallback is null

CMTW ERR LOCK The lock could not be acquired, the channel is busy

Properties

Prototyped in file "r_cmtw_rx_if.h"

Description

This function sets up a CMTW channel. After completion of the open function the CMTW channel will be initialized and ready to be started by calling R_CMTW_Control(). This function must be called once prior to calling any other CMTW API functions. Once successfully completed, the status of the selected CMTW channel will be set to "open". After that this function should not be called again for the same CMTW channel without first performing a "close" by calling R_CMTW_Close().

Example 1

This example sets up channel 0 for 500 ms compare match operation with callback. Note that the clear source is set to CMTW_CLR_CMT to generate 500 ms timer tick. There is only one clear source that can be set for a given channel among the available clear source events. If an incorrect clear source is selected, the timer counter will not be cleared until it rolls over which may take a long time or never happen. The example shows a user provided callback function cb that will be called to notify the user each time compare match event occurs.

```
cmtw_err_t rc;
cmtw_channel_settings_t ch;

/* Clear all fields of the cmtw_channel_settings_t structure */
memset(&ch, 0, sizeof(ch));
```

```
/* Setup for 500 ms compare match with callback */
ch.time_unit = CMTW_TIME_MSEC;
ch.clock_divisor = CMTW_CLK_DIV_8;
ch.clear_source = CMTW_CLR_CMT;
ch.cm_timer.time = 500;
ch.cm_timer.actions = CMTW_ACTION_CALLBACK;
rc = R_CMTW_Open(CMTW_CHANNEL_0, &ch, &cb);

if (CMTW_SUCCESS != rc)
{
/* Handle the error */
}
```

Example 2

This example sets up channel 0 for output compare 0 (OC0) and output compare 1 (OC1) operation. OC0 action is set to CMTW_ACTION_TIMER so no interrupt will be generated for that event. If the PC7 pin is setup for TOC0, it will toggle at a rate of 50 ms. The reason for this is that the clear source is CMTW_CLR_OC1. This means that the timer counter will clear at every OC1 event which is set to 50 ms. 10 ms into this time, OC0 event will happen thus generating 2 events that have the same period with a phase shift. To toggle the PE7 pin, it must be setup for TOC1. Since OC1 action is setup for callback, the user provided callback function cb will be called from the OC1 ISR for channel 0.

In this example if the clear source is set to CMTW_CLR_OC0, it will result in TOC0 toggling at 10 ms rate. Since the timer counter will clear at 10 ms, it will not reach 50 ms and OC1 event will not occur.

```
cmtw err t rc;
cmtw channel settings t ch;
/* Clear all fields of the cmtw channel settings t structure */
memset(&ch, 0, sizeof(ch));
/* Setup 50 ms output compare with TOCO and TOC1 toggle */
ch.time unit = CMTW TIME MSEC;
ch.clock divisor = CMTW CLK DIV 8;
ch.clear_source = CMTW_CLR_OC1;
ch.oc\_timer\_0.time = 1\overline{0};
ch.oc_timer_0.actions = CMTW_ACTION_TIMER;
ch.oc_timer_0.output = CMTW_OUTPUT_HI_TOGGLE;
ch.oc_timer_1.time = 50;
ch.oc_timer_1.actions = CMTW_ACTION CALLBACK;
ch.oc_timer_1.output = CMTW_OUTPUT HI TOGGLE;
rc = R_CMTW_Open(CMTW_CHANNEL 0, &ch, &cb);
if (CMTW SUCCESS != rc)
/* Handle the error */
```

Example 3

This example sets up channel 1 for input capture 0 (IC0) operation. The PD2 pin must be assigned to TIC2 prior to calling CMTW API functions for correct behavior. The clear source is set to CMTW_CLR_DISABLED and therefore timer counter is not cleared when a TIC2 event, which is set to any edge, occurs. The user provided callback function cb will be called from the IC0 ISR for channel 1 when an edge change is detected. Channel number, ISR event, and the timer value (in timer tick count) at which the event happened are passed to the callback function. If the number of counts between the two TIC2 events are needed, it can be calculated by subtracting the current count from the previous one in the callback function.

```
cmtw_err_t rc;
cmtw channel settings t ch;
```



```
/* Clear all fields of the cmtw_channel_settings_t structure */
memset(&ch, 0, sizeof(ch));

/* Setup input capture with no clear */
ch.time_unit = CMTW_TIME_USEC;
ch.clock_divisor = CMTW_CLK_DIV_128;
ch.clear_source = CMTW_CLR_DISABLED;
ch.ic_timer_0.actions = CMTW_ACTION_CALLBACK;
ch.ic_timer_0.edge = CMTW_EDGE_ANY;
rc = R_CMTW_Open(CMTW_CHANNEL_1, &ch, &cb);

if (CMTW_SUCCESS != rc)
{
    /* Handle the error */
}
```

Example 4

This is an example of a callback function for example 3. The void pointer pdata is type-casted to (cmtw_callback_data_t*) to properly access the data. The data type information is available in the r_cmtw_rx_if.h file. Previous and current count values are saved in the global variables. The time between two TIC2 events is simply the difference of these values. Since the timer tick information is available to the user (e.g. the peripheral clock and CMTW clock divisor), actual time can be calculated easily.

```
/* Global variables */
uint32_t    g_previous_count;
uint32_t    g_current_count;
uint32_t    g_delta_count;

void cb(void *pdata)
{
    cmtw_callback_data_t cb_data;
    cmtw_callback_data_t *p_cb_data = (cmtw_callback_data_t *)pdata;

    cb_data.channel = p_cb_data->channel;
    cb_data.event = p_cb_data->event;
    cb_data.count = p_cb_data->count;

    g_previous_count = g_current_count;
    g_current_count = cb_data.count;
    g_delta_count = g_current_count - g_previous_count;
}
```

Special Notes:

None

R_CMTW_Control()

This function starts, stops, resumes, or restarts a CMTW channel that is in the open state.

Format

Parameters

channel

Number of the CMTW channel to control

cmd

Enumerated command codes:

CMTW_CMD_START Activate the timer
CMTW_CMD_RESUME Same as start
CMTW_CMD_STOP Pause the timer

CMTW_CMD_RESTART Zero the counter then activate the timer

Return Values

CMTW_SUCCESS Successful, the command is executed

CMTW_ERR_BAD_CHAN Invalid channel number

CMTW_ERR_CH_NOT_ENABLED Channel is disabled by user configuration

CMTW_ERR_CH_NOT_OPENED Channel currently closed, perform R_CMTW_Open() first

CMTW_ERR_CH_NOT_RUNNIG Channel currently not started - perform R_CMTW_Control() to start

CMTW_ERR_CH_NOT_STOPPED Channel currently running - perform R_CMTW_Control() to stop

CMTW_ERR_LOCK The lock could not be acquired, the channel is busy

Properties

Prototyped in file "r_cmtw_rx_if.h"

Description

This function starts or resumes a CMTW channel that is in the open state. Once successfully completed, the status of the selected CMTW channel will be set to "running". Stop command pauses a channel that is in a running state. In this state the timer registers retain their values immediately before executing the stop command. Timer operations can be continued by start or resume commands. The restart command clears the timer counter and resumes the operations.

Example 1

This example starts channel 0 that is in the open state.

```
/* Open the timer */
rc = R_CMTW_Open(CMTW_CHANNEL_0, &ch, &cb);

if (CMTW_SUCCESS != rc)
{
   /* Handle the error */
}

/* And start it */
rc = R_CMTW_Control(CMTW_CHANNEL_0, CMTW_CMD_START);

if (CMTW_SUCCESS != rc)
{
```

```
/* Handle the error */
```

Example 2

This example stops channel 0 that is in the running state.

```
/* Open the timer */
rc = R_CMTW_Open(CMTW_CHANNEL_0, &ch, &cb);
if (CMTW SUCCESS != rc)
/* Handle the error */
/* And start it */
rc = R_CMTW_Control(CMTW_CHANNEL_0, CMTW_CMD_START);
if (CMTW SUCCESS != rc)
/* Handle the error */
/* Now stop it */
rc = R CMTW Control(CMTW CHANNEL 0, CMTW CMD STOP);
if (CMTW SUCCESS != rc)
/* Handle the error */
```

Special Notes:

None

R CMTW Close()

Disables the specified CMTW channel and powers it down. The channel moves to the closed state.

Format

```
cmtw_err_t R_CMTW_Close(cmtw_channel_t channel);
```

Parameters

channel

Number of the CMTW channel to close

Return Values

CMTW_SUCCESS Successful, channel is closed

CMTW_ERR_BAD_CHAN Invalid channel number

CMTW ERR CH NOT ENABLED Channel is disabled by user configuration

CMTW_ERR_CH_NOT_OPENED Channel currently closed, perform R_CMTW_Open() first

CMTW ERR LOCK The lock could not be acquired, the channel is busy

Properties

Prototyped in file "r cmtw rx if.h"

Description

This function stops and disables a CMTW channel that is in the open or running state. Once successfully completed, the status of the selected CMTW channel will be set to "stopped" and the channel is powered down to reduce power consumption. The channel cannot be used again until it has been reopened with the R_CMTW_Open() function.

Example 1

This example closes channel 0.

```
/* Close the timer */
rc = R_CMTW_Close(CMTW_CHANNEL_0);
if (CMTW_SUCCESS != rc)
{
/* Handle the error */
}
```

Special Notes:

None .



R_CMTW_GetVersion()

This function returns the driver version number at runtime.

Format

```
uint32 t     R CMTW GetVersion(void);
```

Parameters

None

Return Values

Version number with major and minor version digits packed into a single 32-bit value.

Properties

Prototyped in file "r_cmtw_rx_if.h"

Description

This function returns the version of this module. The version number is encoded such that the top 2 bytes are the major version number and the bottom 2 bytes are the minor version number.

Example

This example shows how this function may be used.

```
/* Retrieve the version number and convert it to a string. */
uint32_t version, major, minor;
char version_str[11];

version = R_CMTW_GetVersion();

major = (version >> 16) &0xf;
minor = version & 0xff;

sprintf(version str, "CMTW v%1.0hu.%2.2hu", major, minor);
```

Special Notes:

None

4. Pin Setting

To use the CMTW FIT module, assign input/output signals of the peripheral function to pins with the multi-function pin controller (MPC). The pin assignment is referred to as the "Pin Setting" in this document. Please perform the pin setting after calling the R_CMTW_Open() function.

When performing the Pin Setting in the e² studio, the Pin Setting feature of the FIT configurator or the Smart Configurator can be used. When using the Pin Setting feature, a source file is generated according to the option selected in the Pin Setting window in the FIT configurator or the Smart Configurator. Pins are configured by calling the function defined in the source file.

5. Demo Projects

Demo projects are complete stand-alone programs. They include function main() that utilizes the module and its dependent modules (e.g., r_bsp). The standard naming convention for the demo project is <module>_demo_<board> where <module> is the peripheral acronym (e.g. s12ad, cmt, sci) and the <board> is the standard RSK (e.g. rskrx113). For example, s12ad FIT module demo project for RSKRX113 will be named as s12ad_demo_rskrx113. Similarly the exported .zip file will be <module>_demo_

<module>_demo_

<module>_demo_rskrx113.zip

5.1 cmtw_demo_rskrx64m, cmtw_demo_rskrx64m_gcc

Description

This is a simple demo of the RX64M Compare Match Timer Wide (CMTW) for the RSKRX64M starter kit (FIT module "r_cmtw_rx"). The demo configures channel 0 for a 500 ms compare match operation with interrupt callback, and channel 1 is configured for a 1 sec compare match operation with interrupt callback. When a compare match interrupt is generated by channel 0, the interrupt callback function is called and LED 0 is toggled (every 500 ms). When a compare match interrupt is generated by channel 1, the interrupt callback function is called and LED 1 is toggled (every 1 sec).

Setup and Execution

- 1. Compile and download the sample code.
- 2. Click 'Reset Go' to start the software. If PC stops at Main, press F8 to resume.
- 3. Set breakpoints and watch global variables

Boards Supported

RSKRX64M

5.2 cmtw_demo_rskrx71m, cmtw_demo_rskrx71m_gcc

Description

This is a simple demo of the RX71M Compare Match Timer Wide (CMTW) for the RSKRX71M starter kit (FIT module "r_cmtw_rx"). The demo configures channel 0 for a 500 ms compare match operation with interrupt callback, and channel 1 is configured for a 1 sec compare match operation with interrupt callback. When a compare match interrupt is generated by channel 0, the interrupt callback function is called and LED 0 is toggled (every 500 ms). When a compare match interrupt is generated by channel 1, the interrupt callback function is called and LED 1 is toggled (every 1 sec).

Setup and Execution

- 1. Compile and download the sample code.
- 2. Click 'Reset Go' to start the software. If PC stops at Main, press F8 to resume.
- 3. Set breakpoints and watch global variables
- 4. Click 'Reset Go' to start the software. If PC stops at Main, press F8 to resume.
- 5. Set breakpoints and watch global variables

Boards Supported

RSKRX71M



5.3 cmtw demo rskrx72m, cmtw demo rskrx72m gcc

Description

This is a simple demo of the RX72M Compare Match Timer Wide (CMTW) for the RSKRX72M starter kit (FIT module "r_cmtw_rx"). The demo configures channel 0 for a 500 ms compare match operation with interrupt callback, and channel 1 is configured for a 1 sec compare match operation with interrupt callback. When a compare match interrupt is generated by channel 0, the interrupt callback function is called and LED 0 is toggled (every 500 ms). When a compare match interrupt is generated by channel 1, the interrupt callback function is called and LED 1 is toggled (every 1 sec).

Setup and Execution

- 1. Compile and download the sample code.
- 2. Click 'Reset Go' to start the software. If PC stops at Main, press F8 to resume.
- 3. Set breakpoints and watch global variables

Boards Supported

RSKRX72M

5.4 cmtw_demo_rskrx65n, cmtw_demo_rskrx65n_gcc

Description

This is a simple demo of the RX65N Compare Match Timer Wide (CMTW) for the RSKRX65N starter kit (FIT module "r_cmtw_rx"). The demo configures channel 0 for a 500 ms compare match operation with interrupt callback, and channel 1 is configured for a 1 sec compare match operation with interrupt callback. When a compare match interrupt is generated by channel 0, the interrupt callback function is called and LED 0 is toggled (every 500 ms). When a compare match interrupt is generated by channel 1, the interrupt callback function is called and LED 1 is toggled (every 1 sec).

Setup and Execution

- 1. Compile and download the sample code.
- 2. Click 'Reset Go' to start the software. If PC stops at Main, press F8 to resume.
- 3. Set breakpoints and watch global variables

Boards Supported

RSKRX65N

5.5 cmtw_demo_rskrx65n_2m, cmtw_demo_rskrx65n_2m_gcc

Description

This is a simple demo of the RX65N-2MB Compare Match Timer Wide (CMTW) for the RSKRX65N-2MB starter kit (FIT module "r_cmtw_rx"). The demo configures channel 0 for a 500 ms compare match operation with interrupt callback, and channel 1 is configured for a 1 sec compare match operation with interrupt callback. When a compare match interrupt is generated by channel 0, the interrupt callback function is called and LED 0 is toggled (every 500 ms). When a compare match interrupt is generated by channel 1, the interrupt callback function is called and LED 1 is toggled (every 1 sec).

Setup and Execution

- 1. Compile and download the sample code.
- 2. Click 'Reset Go' to start the software. If PC stops at Main, press F8 to resume.
- 3. Set breakpoints and watch global variables

Boards Supported

RSKRX65N-2MB

5.6 cmtw_demo_rskrx671, cmtw_demo_rskrx671_gcc

Description

This is a simple demo of the RX671 Compare Match Timer Wide (CMTW) for the RSKRX671 starter kit (FIT module "r_cmtw_rx"). The demo configures channel 0 for a 500 ms compare match operation with interrupt callback, and channel 1 is configured for a 1 sec compare match operation with interrupt callback. When a compare match interrupt is generated by channel 0, the interrupt callback function is called and LED 0 is toggled (every 500 ms). When a compare match interrupt is generated by channel 1, the interrupt callback function is called and LED 1 is toggled (every 1 sec).

Setup and Execution

- 1. Compile and download the sample code.
- 2. Click 'Reset Go' to start the software. If PC stops at Main, press F8 to resume.
- 3. Set breakpoints and watch global variables

Boards Supported

RSKRX671

5.7 Adding a Demo to a Workspace

Demo projects are found in the FITDemos subdirectory of the distribution file for this application note. To add a demo project to a workspace, select *File* >> *Import* >> *General* >> *Existing Projects into Workspace*, then click "Next". From the Import Projects dialog, choose the "Select archive file" radio button. "Browse" to the FITDemos subdirectory, select the desired demo zip file, then click "Finish".

5.8 Downloading Demo Projects

Demo projects are not included in the RX Driver Package. When using the demo project, the FIT module needs to be downloaded. To download the FIT module, right click on this application note and select "Sample Code (download)" from the context menu in the *Smart Brower* >> *Application Notes* tab.

6. Appendices

6.1 Operation Confirmation Environment

This section describes operation confirmation environment for the CMTW FIT module.

Table 6.1 Confirmed Operation Environment (Rev.2.91)

Item	Contents					
Integrated development	Renesas Electronics e ² studio Version 2025-01					
environment	IAR Embedded Workbench for Renesas RX 5.10.1					
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.07.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99					
	GCC for Renesas RX 8.3.0.202411					
	Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99					
	Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:					
	-WI,no-gc-sections					
	This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module					
	IAR C/C++ Compiler for Renesas RX version 5.10.1					
	Compiler option: The default settings of the integrated development environment.					
Endian	Big endian/little endian					
Revision of the module	Rev.2.91					
Board used	-					

Table 6.2 Confirmed Operation Environment (Rev.2.90)

Item	Contents
Integrated development	Renesas Electronics e ² studio Version 2024-01.1
environment	IAR Embedded Workbench for Renesas RX 5.10.1
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.06.00
	Compiler option: The following option is added to the default settings of the
	integrated development environment.
	-lang = c99
	GCC for Renesas RX 8.3.0.202311
	Compiler option: The following option is added to the default settings of the
	integrated development environment.
	-std=gnu99
	Linker option: The following user defined option should be added to the
	default settings of the integrated development environment, if "Optimize size
	(-Os)" is used:
	-WI,no-gc-sections
	This is to work around a GCC linker issue whereby the linker erroneously
	discard interrupt functions declared in FIT peripheral module
	IAR C/C++ Compiler for Renesas RX version 5.10.1
	Compiler option: The default settings of the integrated development
	environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.90
Board used	Renesas Starter Kit+ for RX72N (product No.: RTK5572Nxxxxxxxxxxx)

Table 6.3 Confirmed Operation Environment (Rev.2.80)

Item	Contents						
Integrated development	Renesas Electronics e ² studio Version 2022-10						
environment	IAR Embedded Workbench for Renesas RX 4.20.3						
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.05.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99						
	GCC for Renesas RX 8.3.0.202204 Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99						
	Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -WI,no-gc-sections						
	This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module						
	IAR C/C++ Compiler for Renesas RX version 4.20.3 Compiler option: The default settings of the integrated development environment.						
Endian	Big endian/little endian						
Revision of the module	Rev.2.80						
Board used	Renesas Flexible Motor Control Kit for RX26T (Part Number: RTK0EMXE70SxxxxxBJ)						

Table 6.4 Confirmed Operation Environment (Rev.2.70)

Item	Contents
Integrated development	Renesas Electronics e ² studio Version 2022-07
environment	IAR Embedded Workbench for Renesas RX 4.20.3
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.04.00 Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99
	GCC for Renesas RX 8.3.0.202104 Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99
	Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -WI,no-gc-sections
	This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module
	IAR C/C++ Compiler for Renesas RX version 4.20.3 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.70
Board used	Renesas Starter Kit for RX64M (product No.: R0K50564MxxxxBE)
	Renesas Starter Kit+ for RX65N (product No.: RTK5005651CxxxxxBE) Renesas Starter Kit+ for RX65N-2MB (product No.: RTK50565N2CxxxxxBR) Renesas Starter Kit for RX71M (product No.: R0K50571MCxxxBE) Renesas Starter Kit+ for RX72M (product No.: RTK5572MNDCxxxxxBJ) Renesas Starter Kit+ for RX671 (product No.: RTK55671EDCxxxxxBJ)

Table 6.5 Confirmed Operation Environment (Rev.2.60)

Item	Contents			
Integrated development	Renesas Electronics e ² studio Version 2022-04			
environment	IAR Embedded Workbench for Renesas RX 4.20.3			
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.04.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99 GCC for Renesas RX 8.3.0.202104			
	Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99			
	Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -WI,no-gc-sections			
	This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module			
	IAR C/C++ Compiler for Renesas RX version 4.20.3			
	Compiler option: The default settings of the integrated development environment.			
Endian	Big endian/little endian			
Revision of the module	Rev.2.60			
Board used	Renesas Starter Kit for RX660 (product No: RTK556609HCxxxxxBJ)			

Table 6.6 Confirmed Operation Environment (Rev.2.50)

Item	Contents			
Integrated development	Renesas Electronics e ² studio Version 2021-07			
environment	IAR Embedded Workbench for Renesas RX 4.20.3			
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00 Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99			
	GCC for Renesas RX 8.3.0.202004			
	Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99			
	Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:			
	-WI,no-gc-sections			
	This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module			
	IAR C/C++ Compiler for Renesas RX version 4.20.3			
	Compiler option: The default settings of the integrated development environment.			
Endian	Big endian/little endian			
Revision of the module	Rev.2.50			
Board used	Renesas Starter Kit+ for RX671 (product No.: RTK55671xxxxxxxxxxx)			

Table 6.7 Confirmed Operation Environment (Rev.2.40)

Item	Contents			
Integrated development	Renesas Electronics e ² studio Version 2021-07			
environment	IAR Embedded Workbench for Renesas RX 4.20.3			
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00 Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99			
	GCC for Renesas RX 8.3.0.202004 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99			
	Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -WI,no-gc-sections			
	This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module			
	IAR C/C++ Compiler for Renesas RX version 4.20.3			
	Compiler option: The default settings of the integrated development environment.			
Endian	Big endian/little endian			
Revision of the module	Rev.2.40			
Board used	Renesas Starter Kit+ for RX671 (product No.: RTK55671xxxxxxxxxx)			

Table 6.8 Confirmed Operation Environment (Rev.2.30)

Item	Contents		
Integrated development environment	Renesas Electronics e ² studio Version 7.8.0		
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00 Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99		
	GCC for Renesas RX 8.3.0.201904 Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:		
- Fall or	-WI,no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module		
Endian Revision of the module	Little endian Rev.2.30		
Board used	Renesas Starter Kit+ for RX72M (product No.: RTK5572Mxxxxxxxxxx) Renesas Starter Kit+ for RX65N-2MB (product No.: RTK50565N2CxxxxxBR) Renesas Starter Kit+ for RX65N (product No.: RTK50565NCxxxxxBE) Renesas Starter Kit+ for RX64M (product No.: RTK50564Mxxxxxxxxx)		
	Renesas Starter Kit+ for RX71M (product No.: RTK50571Mxxxxxxxx)		

Table 6.9 Confirmed Operation Environment (Rev.2.20)

Item	Contents			
Integrated development	Renesas Electronics e ² studio Version 7.7.0			
environment	IAR Embedded Workbench for Renesas RX 4.12.1			
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00 Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99			
	GCC for Renesas RX 4.8.4.201902			
	Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99			
	Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -WI,no-gc-sections			
	This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module			
	IAR C/C++ Compiler for Renesas RX version 4.12.1			
	Compiler option: The default settings of the integrated development environment.			
Endian	Big endian/little endian			
Revision of the module	Rev.2.20			
Board used	Renesas Starter Kit+ for RX72N (product No.: RTK5572Nxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxx			

Table 6.10 Confirmed Operation Environment (Rev.2.10)

Item	Contents			
Integrated development	Renesas Electronics e ² studio Version 7.5.0			
environment	IAR Embedded Workbench for Renesas RX 4.12.1			
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00 Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99			
	GCC for Renesas RX 4.8.4.201902			
	Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99			
	Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -WI,no-gc-sections			
	This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module			
	IAR C/C++ Compiler for Renesas RX version 4.12.1			
	Compiler option: The default settings of the integrated development environment.			
Endian	Big endian/little endian			
Revision of the module	Rev.2.10			
Board used	Renesas Starter Kit+ for RX72M (product No.: RTK5572Mxxxxxxxxxx)			

Table 6.11 Confirmed Operation Environment (Rev.2.00)

Item	Contents			
Integrated development	Renesas Electronics e ² studio Version 7.4.0			
environment	IAR Embedded Workbench for Renesas RX 4.10.1			
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99			
	GCC for Renesas RX 4.8.4.201803			
	Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99			
	Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:			
	-WI,no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously			
	discard interrupt functions declared in FIT peripheral module			
	IAR C/C++ Compiler for Renesas RX version 4.10.1			
	Compiler option: The default settings of the integrated development environment.			
Endian	Big endian/little endian			
Revision of the module	Rev.2.00			
Board used	Renesas Starter Kit+ for RX65N-2MB (product No.: RTK50565Nxxxxxxxxxx)			

Table 6.12 Operation Confirmation Environment (Rev.1.32)

Item	Contents		
Integrated development environment	Renesas Electronics e ² studio Version 7.3.0		
	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00		
C compiler	Compiler option: The following option is added to the default settings of the		
C compiler	integrated development environment.		
	-lang = c99		
Endian	Big endian/little endian		
Revision of the module	Rev.1.32		
Board used	Renesas Starter Kit+ for RX65N-2MB (product No.: RTK50565N2CxxxxxBR)		

Table 6.13 Operation Confirmation Environment (Rev.1.31)

Item	Contents		
Integrated development environment	Renesas Electronics e ² studio Version 6.0.0		
	Renesas Electronics C/C++ Compiler Package for RX Family V2.07.00		
C compiler	Compiler option: The following option is added to the default settings of the		
C compiler	integrated development environment.		
_	-lang = c99		
Endian	Big endian/little endian		
Revision of the module	Rev.1.31		
Board used	Renesas Starter Kit+ for RX65N-2MB (product No.: RTK50565N2CxxxxxBR)		

Table 6.14 Operation Confirmation Environment (Rev.1.30)

Item	Contents		
Integrated development environment	Renesas Electronics e ² studio Version 6.0.0		
	Renesas Electronics C/C++ Compiler Package for RX Family V2.07.00		
C compiler	Compiler option: The following option is added to the default settings of the		
C compiler	integrated development environment.		
	-lang = c99		
Endian	Big endian/little endian		
Revision of the module	Rev.1.30		
Board used	Renesas Starter Kit+ for RX65N-2MB (product No.: RTK50565N2CxxxxxBR)		

6.2 Troubleshooting

- (1) Q: I have added the FIT module to the project and built it. Then I got the error: Could not open source file "platform.h".
 - A: The FIT module may not be added to the project properly. Check if the method for adding FIT modules is correct with the following documents:
 - Using CS+:

Application note "Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)"

Using e² studio:

Application note "Adding Firmware Integration Technology Modules to Projects (R01AN1723)"

When using a FIT module, the board support package FIT module (BSP module) must also be added to the project. Refer to the application note "Board Support Package Module Using Firmware Integration Technology (R01AN1685)".

- (2) Q: I have added the FIT module to the project and built it. Then I got the error: This MCU is not supported by the current r_cmtw_rx module.
 - A: The FIT module you added may not support the target device chosen in your project. Check the supported devices of added FIT modules.
- (3) Q: I have added the FIT module to the project and built it. Then I got an error for when the configuration setting is wrong.
 - A: The setting in the file "r_cmtw_rx_config.h" may be wrong. Check the file "r_cmtw_rx_config.h". If there is a wrong setting, set the correct value for that. Refer to 2.9 Configuration Overview for details.
- (4) Q: The expected waveform is not output.
 - A: The pin setting may not be performed correctly. When using this FIT module, the pin setting must be performed. Refer to 4. Pin Setting for details.

Related Technical Updates

This module reflects the content of the following technical updates. None

Revision History

		Descriptio	n
Rev.	Date	Page	Summary
1.00	Sept 3, 2014		First edition issued
1.10	Mar 2, 2015		Added support for the RX71M Group
1.20	Oct 1, 2016		Added support for the RX65N Group
		8	Changed the tabular format of Code Size.
			Updated the Code Size table for the RX65N Group.
		21	Added "4. Pin Setting".
		23	Added "Related Technical Updates".
1.30	Jul 21, 2017		Added support for the RX65N-2MB.
		6	Added RXC v2.06.00, RXC v2.07.00 to "2.5 Supported
			Toolchains"
		7	Added "2.6 Interrupt Vector"
		13	Updated "2.13 Adding the FIT Module to Your Project"
		22	Updated "4. Pin Setting".
1.31	Oct 31, 2017	24	Added "5.3 cmtw_demo_rskrx65n"
		24	Added "5.4 cmtw_demo_rskrx65n_2m"
		24	Added "5.6 Downloading Demo Projects"
		25	Added "6. Appendices"
1.32	Nov 16, 2018		Added document number in XML
		6	Added RXC v3.01.00 to "2.5 Supported Toolchains"
		13	Updated "2.13 Adding the FIT Module to Your Project"
		14	Added "2.14 "for", "while" and "do while" statements"
-		26	Added table for Rev.1.32
1.40	Feb 01, 2019	8	Corrected interrupt priority level macro names
		16-22	Removed 'Reentrant' description in each API function.
2.00	May.20.19	_	Supported the following compilers:
			- GCC for Renesas RX
			- IAR C/C++ Compiler for Renesas RX
		1	Added the section of Target compilers.
			Deleted related documents.
		6	2.3 Software Requirements
		0	Requires r_bsp v5.20 or higher
		9	Updated the section of 2.10 Code Size
		26	Table 6.1 Confirmed Operation Environment:
		00	Added table for Rev.2.00
		29	Deleted the section of Website and Support.
		Program	Changed below for support GCC and IAR compiler:
			 Deleted the inline expansion of the R_CMTW_GetVersion function.
			Replaced evenaccess with the macro definition of BSP.
			3. Replaced the declaration of interrupt functions with the macro definition of BSP.

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2.10	Aug.15.19	1, 7	Added support for RX72M
	J	10	Added code size corresponding to RX72M
		26	6.1 Confirmed Operation Environment:
			Added Table for Rev.2.10
		Program	Added support for RX72M.
2.20	Dec.30.19	1, 7	Added support for RX66N, RX72N
	200.000	6	2.4 Limitations
		· ·	Added limitations.
		10	Added code size corresponding to RX66N, RX72N
		25	6.1 Confirmed Operation Environment:
			Added Table for Rev.2.20
		Program	Added support for RX66N, RX72N.
2.30	Jun.30.20	23-25	Updated and added new demo project
		24	Added RSKRX72M to "5. Demo Projects"
		26	6.1 Confirmed Operation Environment:
			Added Table for Rev.2.30
		Program	Updated and added new demo project
2.40	Mar.31.21	1	Added support for RX671.
		7	Added 1.4 Using the FIT CMTW module.
			Added 1.4.1 Using FIT CMTW module in C++ project.
		12	Added code size corresponding to RX671.
		29	6.1 Confirmed Operation Environment:
			Added Table for Rev.2.40.
		Program	Added support for RX671
2.50	Sep.13.21	28	Added "5.6 cmtw_demo_rskrx671, cmtw_demo_rskrx671_gcc
	·	30	6.1: Confirm Operation Environment:
			Added Table for Rev. 2.50.
		Program	Updated and added new demo projects
			Added CS+ support for demo project.
2.60	Nov.22.21	1, 9	Added support for RX660.
		13	Added code size corresponding to RX660.
		31	6.1: Confirm Operation Environment:
			Added Table for Rev. 2.60.
		Program	Added support for RX660
2.70	Jun.28.22	28	6.1: Confirm Operation Environment:
			Added Table for Rev. 2.70.
		Program	Updated demo projects
2.80	Aug.15.22	1, 5, 8	Added support for RX26T.
		13	Added code size corresponding to RX26T.
		29	6.1: Confirm Operation Environment:
			Added Table for Rev. 2.80.
		Program	Added support for RX26T
2.90	Nov.01.24	10	Added new macros CMTW_CFG_EN_NESTED_INT to
			support nested interrupt.
		17	Deleted the description of FIT configurator from "2.13 Adding
			the FIT Module to Your Project"
		29	6.1: Confirm Operation Environment:
			Added Table for Rev. 2.90.
		Program	Added support for nested interrupt.
2.91	Mar.15.25	29	6.1: Confirm Operation Environment:
			Added Table for Rev. 2.91.
		Program	Updated FIT Disclaimer and Copyright.

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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